



Product Change Notification

Change Notification #: 118482-00
Change Title: MINOR CHANGE, Select Dynamic Random Access Memory, PCN 118482-00, Label, Transport Media, Change to Standard Intermediate Label and Standard Intermediate Box
Date of Publication: September 10, 2021

Key Characteristics of the Change:
Label, Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	October 10, 2021
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Description of Change to the Customer:

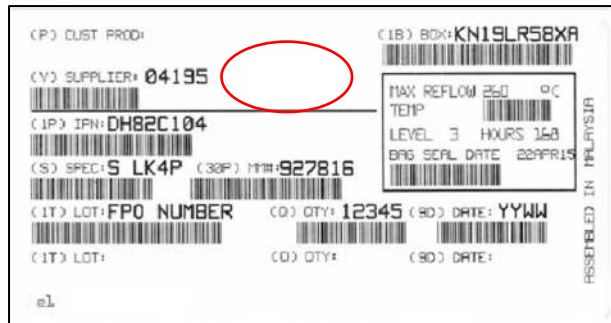
The following two changes will be done on all the materials used to ship the products listed in the Products Affected / Intel Ordering Codes table below:

- 1) Remove the word "INTEL" from the Standard Intermediate Box Label, currently placed on both the Standard Intermediate Box as well as the Moisture Barrier Bag (MBB).

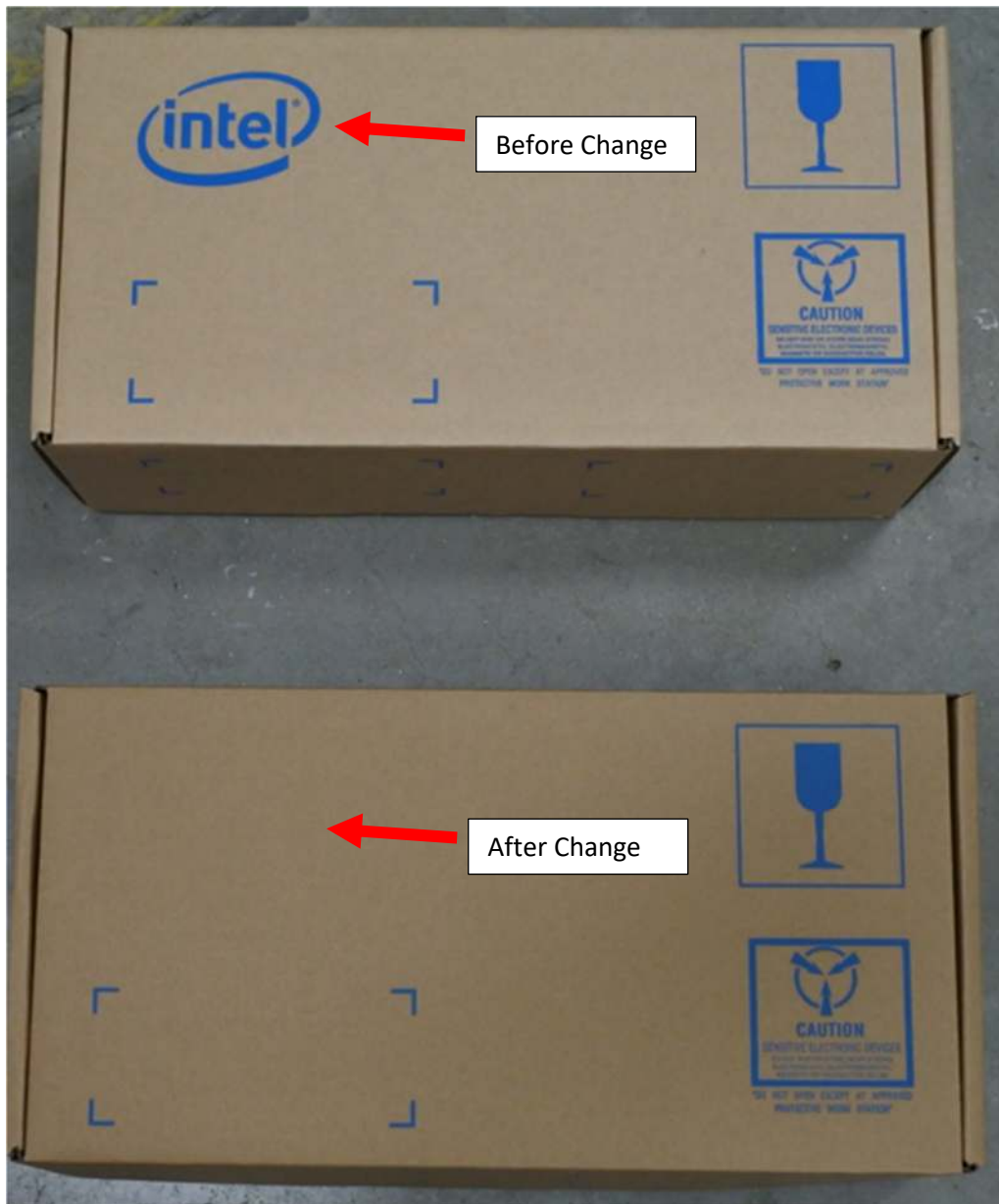
Before



After



2) Remove the Intel Logo from the Standard Intermediate Box.



Intel is making these two minor changes to facilitate a more effective customs management process during the transport of products.

Customer Impact of Change and Recommended Action:

Intel considers both of these changes to be a Minor Change. There is no change to the Form, Fit, Function, Quality or Reliability of the products as a result of this change.

Beginning October 10, 2021, Intel will start labeling and packing products using the new method described above.

Previously packaged inventory with the Intel label values on them and/or packed in the Standard Intermediate Box with the Intel Logo - may still be used until that inventory is depleted. Therefore, customers could expect to see products shipped with both the older and newer methods for several months ahead.

Please communicate this change internally as needed and contact your local Intel representative with any questions or concerns regarding the changes communicated in this notification.

Products Affected/Intel Ordering Codes:

Marketing Name	MM#	Product Code	Spec Code
DYNAMIC RANDOM ACCESS MEMORY	999WNA	CNLPDDR4X1GB	S LNGW
DYNAMIC RANDOM ACCESS MEMORY	99AHMK	CNGDDR62GBX16	S LNYE
DYNAMIC RANDOM ACCESS MEMORY	99AHML	CNGDDR62GBX18	S LNYF
DYNAMIC RANDOM ACCESS MEMORY	99AL6L	CNGDDR61X16	S LP38
DYNAMIC RANDOM ACCESS MEMORY	99AKDD	CNGDDR68X14	S LP2J

PCN Revision History:

Date of Revision:

September 10, 2021

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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